ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INDUSTRIES®	PC. Bannockl	burn. Illinois. A	Ill rights reserved untions.	under both	This docume level parts, t	ent is a declara	tion of the s encompass	substances es all lowe	within the er level mat	manufacture rerials for wh	er listed iten nich the ma	m. Note: i nufacture	if the item is an as r has engineering	sembly with lower responsibility.	
	21.1 IPC Web Site for Information on IPC-1752 Standard Fo http://www.ipc.org/IPC-175x Di				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materia	ials and Mfg Information				
Supplier Information															
Company name*	Company un	Company unique ID			Unique ID Authority					Response Date*					
onsemi											2023-06-08				
Contact Name Title - Conta			Contact			Phone - Contact*				Email - Contact*					
Product-Env-Stewards Product			roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - R			tle - Representative			Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Envi			nviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Iten	n Number	Number Mfr Item Name			Effective Dat	e Version		Manufacturing Site		W	eight*	UOM	Unit Type	
	CAT540	9YI-25-T2	DPP NV, QUAD 64 TAPS, I2C			2023-06-08			TH5		90	.05	mg	Each	
Manufacturing Proccess Informa	tion										·				
Terminal Plating / Grid Array M	minal Plating / Grid Array Material Terminal Base		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature		re Max T	ime at Peak	k Temperature Number of Reflow Cycles		cles			
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260	260 C 30		30		seconds 3				
Comments															
level 1 - maximum time at peak temperat	ire during so	ldering is 10-3	0 seconds												
For more information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead ), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl halate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.												
Supplier Digital Signature Ra	stislav Drska	Le										

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.51	mg	Supplier	Silicon (Si)	7440-21-3		5.51	mg
Die Attach	0.61	mg	Supplier	Silver (Ag)	7440-22-4		0.4575	mg
			Supplier	Epoxy resins	129915-35-1		0.1525	mg
Lead Frame	27.38	mg	Supplier	Silver (Ag)	7440-22-4		0.8241	mg
			Supplier	Magnesium (Mg)	7439-95-4		0.0411	mg
			Supplier	Silicon (Si)	7440-21-3		0.178	mg
			В	Nickel (Ni)	7440-02-0		0.8214	mg
			Supplier	Copper (Cu)	7440-50-8		25.5154	mg
Mold Compound-Black	53.25	mg		Epoxy Phenol Resin	proprietary data		5.5912	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		47.6587	mg
Plating	2.58	mg	Supplier	Tin (Sn)	7440-31-5		2.58	mg
Wire Bond - Au	0.72	mg	Supplier	Gold (Au)	7440-57-5		0.72	mg